

MSM514400A/AL

1,048,576-Word × 4-Bit DYNAMIC RAM : FAST PAGE MODE TYPE

DESCRIPTION

The MSM514400A/AL is a new generation dynamic RAM organized as 1,048,576-word × 4-bit. The technology used to fabricate the MSM514400A/AL is OKI's CMOS silicon gate process technology. The device operates at a single 5V power supply. Its I/O pins are TTL compatible.

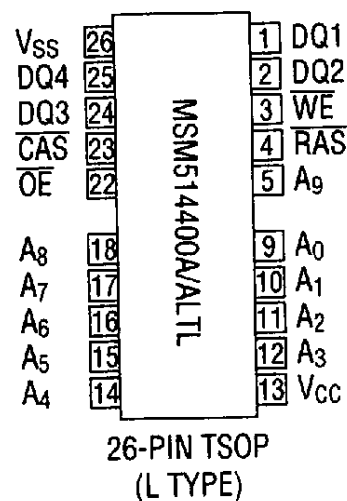
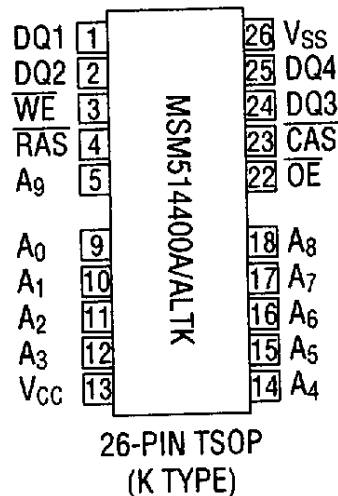
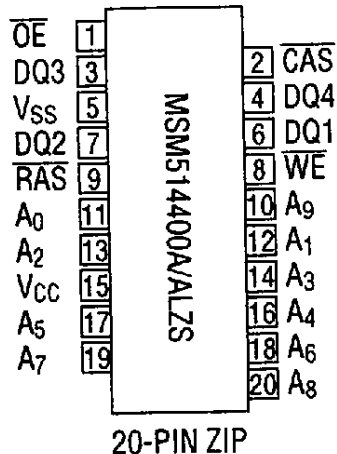
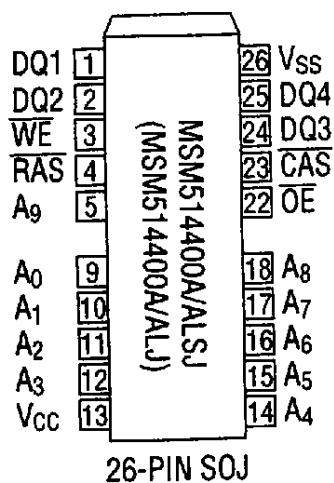
FEATURES

- Silicon gate, quadruple polysilicon CMOS, 1 transistor memory cell
- 1,048,576-word × 4-bit organization
- Single 5V power supply, ±10% tolerance
- Input: TTL compatible
- Output: TTL compatible, tristate
- Refresh: 1024 cycles/16ms, 1024 cycles/128ms (L-version)
- Fast page mode, read modify write capability
- CAS before RAS refresh, Hidden refresh, $\overline{\text{RAS}}$ only refresh capability
- Multibit test mode capability
- Package:
 - 26-Pin 300/350mil Plastic SOJ (SOJ26-P-300), (SOJ26-P-350)
 - 20-Pin 400mil Plastic ZIP (ZIP20-P-400-W1)
 - 26-Pin 300mil Plastic TSOP (TSOP26-P-300-K/L)

PRODUCT FAMILY

Family	Access Time (Max.)				Cycle Time (Min.)	Power Dissipation	
	t _{RAC}	t _{AA}	t _{CAC}	t _{OE}		Operating (Max.)	Standby (Max.)
MSM514400A/AL-70	70ns	35ns	20ns	20ns	130ns	495mW	5.5mW/ 1.1mW (L-version)
MSM514400A/AL-80	80ns	40ns	20ns	20ns	150ns	440mW	
MSM514400A/AL-10	100ns	50ns	25ns	25ns	180ns	385mW	

PIN CONFIGURATION (TOP VIEW)

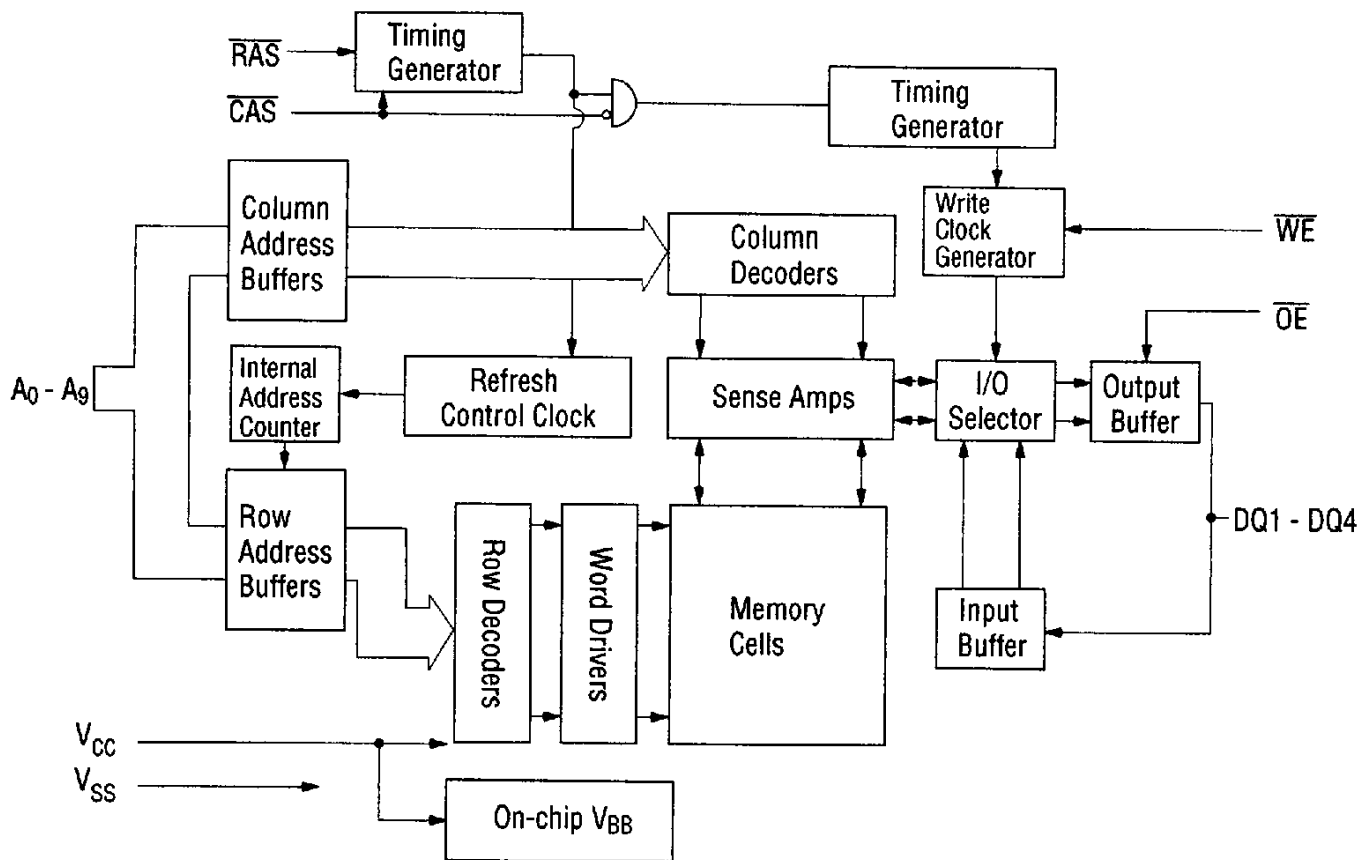


SJ = 300mil

J = 350mil

Pin Name	Function
A ₀ - A ₉	Address Input
$\overline{\text{RAS}}$	Row Address Strobe
$\overline{\text{CAS}}$	Column Address Strobe
DQ1 - DQ4	Data-Input/Data-Output
$\overline{\text{OE}}$	Output Enable
$\overline{\text{WE}}$	Write Enable
V _{CC}	Power Supply (5V)
V _{SS}	Ground (0V)

FUNCTIONAL BLOCK DIAGRAM



ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Voltage on Any Pin Relative to V_{SS}	V_T	-1.0 to 7.0	V
Short Circuit Output Current	I_{OS}	50	mA
Power Dissipation	P_D^*	1	W
Operating Temperature	T_{opr}	0 to 70	°C
Storage Temperature	T_{stg}	-55 to 150	°C

*: $T_a = 25^\circ\text{C}$

Recommended Operating Conditions

(Ta = 0 to 70°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Power Supply Voltage	V_{CC}	4.5	5.0	5.5	V
	V_{SS}	0	0	0	V
Input High Voltage	V_{IH}	2.4	—	6.5	V
Input Low Voltage	V_{IL}	-1.0	—	0.8	V

Capacitance

(V_{CC} = 5V±10%, Ta = 25°C, f = 1MHz)

Parameter	Symbol	Typ.	Max.	Unit
Input Capacitance (A0 - A9)	C_{IN1}	—	6	pF
Input Capacitance ($\overline{RAS}$, $\overline{CAS}$, $\overline{WE}$, $\overline{OE}$)	C_{IN2}	—	7	pF
Output Capacitance (DQ1 - DQ4)	$C_{I/O}$	—	7	pF

DC Characteristics
 $(V_{CC} = 5V \pm 10\%, T_a = 0 \text{ to } 70^\circ\text{C})$

Parameter	Symbol	Condition	MSM 514400A/AL-70		MSM 514400A/AL-80		MSM 514400A/AL-10		Unit	Note
			Min.	Max.	Min.	Max.	Min.	Max.		
Output High Voltage	V_{OH}	$I_{OH} = -5.0\text{mA}$	2.4	V_{CC}	2.4	V_{CC}	2.4	V_{CC}	V	
Output Low Voltage	V_{OL}	$I_{OL} = 4.2\text{mA}$	0	0.4	0	0.4	0	0.4	V	
Input Leakage Current	I_{LI}	$0V \leq V_I \leq 6.5V$; All other pins not under test = 0V	-10	10	-10	10	-10	10	μA	
Output Leakage Current	I_{LO}	DQi disable $0V \leq V_O \leq 5.5V$	-10	10	-10	10	-10	10	μA	
Average Power Supply Current (Operating)	I_{CC1}	$\overline{RAS}$, $\overline{CAS}$ cycling, $t_{RC} = \text{Min.}$	—	90	—	80	—	70	mA	1, 2
Power Supply Current (Standby)	I_{CC2}	$\overline{RAS}$, $\overline{CAS} = V_{IH}$	—	2	—	2	—	2	mA	1
		$\overline{RAS}$, $\overline{CAS} \geq V_{CC} - 0.2V$	—	1	—	1	—	1	mA	
			—	200	—	200	—	200	μA	1, 5
Average Power Supply Current ($\overline{RAS}$ -only Refresh)	I_{CC3}	$\overline{RAS}$ cycling, $\overline{CAS} = V_{IH}$ $t_{RC} = \text{Min.}$	—	90	—	80	—	70	mA	1, 2
Power Supply Current (Standby)	I_{CC5}	$\overline{RAS} = V_{IH}$ $\overline{CAS} = V_{IL}$ DQi = enable	—	5	—	5	—	5	mA	1
Average Power Supply Current ($\overline{CAS}$ Before $\overline{RAS}$ Refresh)	I_{CC6}	$\overline{RAS}$ cycling, $\overline{CAS}$ before $\overline{RAS}$	—	90	—	80	—	70	mA	1, 2
Average Power Supply Current (Fast Page Mode)	I_{CC7}	$\overline{RAS} = V_{IL}$, $\overline{CAS}$ cycling, $t_{PC} = \text{Min.}$	—	80	—	70	—	60	mA	1, 3
Average Power Supply Current (Battery Backup)	I_{CC10}	$t_{RC} = 125\mu\text{s}$ $\overline{CAS}$ before $\overline{RAS}$ $\overline{RAS}$ cycling, $t_{RAS} \leq 1\mu\text{s}$	—	300	—	300	—	300	μA	1, 2, 4, 5

- Notes :
- Specified values are obtained with the output open.
 - Address can be changed once or less while $\overline{RAS} = V_{IL}$.
 - Address can be changed once or less while $\overline{CAS} = V_{IH}$.
 - $V_{CC} - 0.2V \leq V_{IH} \leq 6.5V$, $-1.0V \leq V_{IL} \leq 0.2V$.
 - L-version.

AC Characteristics (1/2)

(V_{CC} = 5V ± 10%, T_a = 0 to 70°C) Note 1, 2, 3, 11

Parameter	Symbol	MSM 514400A/AL-70		MSM 514400A/AL-80		MSM 514400A/AL-10		Unit	Note
		Min.	Max.	Min.	Max.	Min.	Max.		
Random Read or Write Cycle Time	t _{RC}	130	—	150	—	180	—	ns	
Read Modify Write Cycle Time	t _{RMW}	185	—	205	—	245	—	ns	
Fast Page Mode Cycle Time	t _{PC}	50	—	55	—	65	—	ns	
Fast Page Mode Read Modify Write Cycle Time	t _{PRMW}	105	—	110	—	130	—	ns	
Access Time from $\overline{\text{RAS}}$	t _{RAC}	—	70	—	80	—	100	ns	4, 5, 6
Access Time from $\overline{\text{CAS}}$	t _{CAC}	—	20	—	20	—	25	ns	4, 5
Access Time from Column Address	t _{AA}	—	35	—	40	—	50	ns	4, 6
Access Time from $\overline{\text{OE}}$	t _{OE A}	—	20	—	20	—	25	ns	4
Access Time from $\overline{\text{CAS}}$ Precharge	t _{CPA}	—	40	—	45	—	55	ns	4
Output Low Impedance Time from $\overline{\text{CAS}}$	t _{CLZ}	0	—	0	—	0	—	ns	4
Output Buffer Turn-off Delay Time	t _{OFF}	0	20	0	20	0	25	ns	7
$\overline{\text{OE}}$ to Data Output Buffer Turn-off Delay Time	t _{OEZ}	0	20	0	20	0	25	ns	7
Transition Time	t _T	3	50	3	50	3	50	ns	3
Refresh Period	t _{REF}	—	16	—	16	—	16	ms	
Refresh Period (L-version)	t _{REF}	—	128	—	128	—	128	ms	
$\overline{\text{RAS}}$ Precharge Time	t _{RP}	50	—	60	—	70	—	ns	
$\overline{\text{RAS}}$ Pulse Width	t _{RAS}	70	10,000	80	10,000	100	10,000	ns	
$\overline{\text{RAS}}$ Pulse Width (Fast Page Mode)	t _{RASP}	70	100,000	80	100,000	100	100,000	ns	
$\overline{\text{RAS}}$ Hold Time	t _{RSH}	20	—	20	—	25	—	ns	
$\overline{\text{RAS}}$ Hold Time Reference to $\overline{\text{OE}}$	t _{ROH}	20	—	20	—	25	—	ns	
$\overline{\text{CAS}}$ Precharge Time	t _{CP}	10	—	10	—	10	—	ns	
$\overline{\text{CAS}}$ Pulse Width	t _{CAS}	20	10,000	20	10,000	25	10,000	ns	
$\overline{\text{CAS}}$ Hold Time	t _{CSH}	70	—	80	—	100	—	ns	
$\overline{\text{CAS}}$ to $\overline{\text{RAS}}$ Precharge Time	t _{CRP}	5	—	5	—	5	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Delay Time	t _{RCD}	20	50	20	60	25	75	ns	5
$\overline{\text{RAS}}$ to Column Address Delay Time	t _{RAD}	15	35	15	40	20	50	ns	6
Row Address Set-up Time	t _{ASR}	0	—	0	—	0	—	ns	
Row Address Hold Time	t _{RAH}	10	—	10	—	15	—	ns	
Column Address Set-up Time	t _{ASC}	0	—	0	—	0	—	ns	
Column Address Hold Time	t _{CAH}	15	—	15	—	20	—	ns	
Column Address Hold Time from $\overline{\text{RAS}}$	t _{AR}	55	—	60	—	75	—	ns	
Column Address to $\overline{\text{RAS}}$ Lead Time	t _{RAL}	35	—	40	—	50	—	ns	

AC Characteristics (2/2)

(V_{CC} = 5V ± 10%, T_a = 0 to 70°C) Note 1, 2, 3, 11

Parameter	Symbol	MSM 514400A/AL-70		MSM 514400A/AL-80		MSM 514400A/AL-10		Unit	Note
		Min.	Max.	Min.	Max.	Min.	Max.		
Read Command Set-up Time	t _{RCS}	0	—	0	—	0	—	ns	
Read Command Hold Time	t _{RCH}	0	—	0	—	0	—	ns	8
Read Command Hold Time Reference to $\overline{\text{RAS}}$	t _{RRH}	0	—	0	—	0	—	ns	8
Write Command Set-up Time	t _{WCS}	0	—	0	—	0	—	ns	9
Write Command Hold Time	t _{WCH}	10	—	15	—	20	—	ns	
Write Command Pulse Width	t _{WP}	10	—	15	—	20	—	ns	
Write Command Hold Time from $\overline{\text{RAS}}$	t _{WCR}	50	—	60	—	75	—	ns	
$\overline{\text{OE}}$ Command Hold Time	t _{OEH}	20	—	20	—	25	—	ns	
Write Command to $\overline{\text{CAS}}$ Lead Time	t _{CWL}	20	—	20	—	25	—	ns	
Write Command to $\overline{\text{RAS}}$ Lead Time	t _{RWL}	20	—	20	—	25	—	ns	
Data-in Set-up Time	t _{DS}	0	—	0	—	0	—	ns	10
Data-in Hold Time	t _{DH}	15	—	15	—	20	—	ns	10
Data-in Hold Time from $\overline{\text{RAS}}$	t _{DHR}	55	—	60	—	75	—	ns	
$\overline{\text{OE}}$ to Data-in Delay Time	t _{OEED}	20	—	20	—	25	—	ns	
$\overline{\text{CAS}}$ to $\overline{\text{WE}}$ Delay Time	t _{CWD}	50	—	50	—	60	—	ns	9
Column Address to $\overline{\text{WE}}$ Delay Time	t _{AWD}	65	—	70	—	85	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{WE}}$ Delay Time	t _{RWD}	100	—	110	—	135	—	ns	9
$\overline{\text{CAS}}$ Active Delay from $\overline{\text{RAS}}$ Precharge	t _{RPC}	5	—	5	—	5	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Set-up Time ($\overline{\text{CAS}}$ Before $\overline{\text{RAS}}$)	t _{CSR}	5	—	5	—	5	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ Hold Time ($\overline{\text{CAS}}$ Before $\overline{\text{RAS}}$)	t _{CHR}	15	—	15	—	15	—	ns	
$\overline{\text{CAS}}$ Precharge Time (Refresh Counter Test)	t _{CPT}	35	—	40	—	50	—	ns	
$\overline{\text{WE}}$ to $\overline{\text{RAS}}$ Precharge Time ($\overline{\text{CAS}}$ Before $\overline{\text{RAS}}$)	t _{WRP}	10	—	10	—	10	—	ns	
$\overline{\text{WE}}$ Hold Time from $\overline{\text{RAS}}$ ($\overline{\text{CAS}}$ Before $\overline{\text{RAS}}$)	t _{WRH}	10	—	10	—	10	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{WE}}$ Set-up Time (Test Mode)	t _{WSR}	10	—	10	—	10	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{WE}}$ Hold Time (Test Mode)	t _{WHR}	10	—	10	—	10	—	ns	

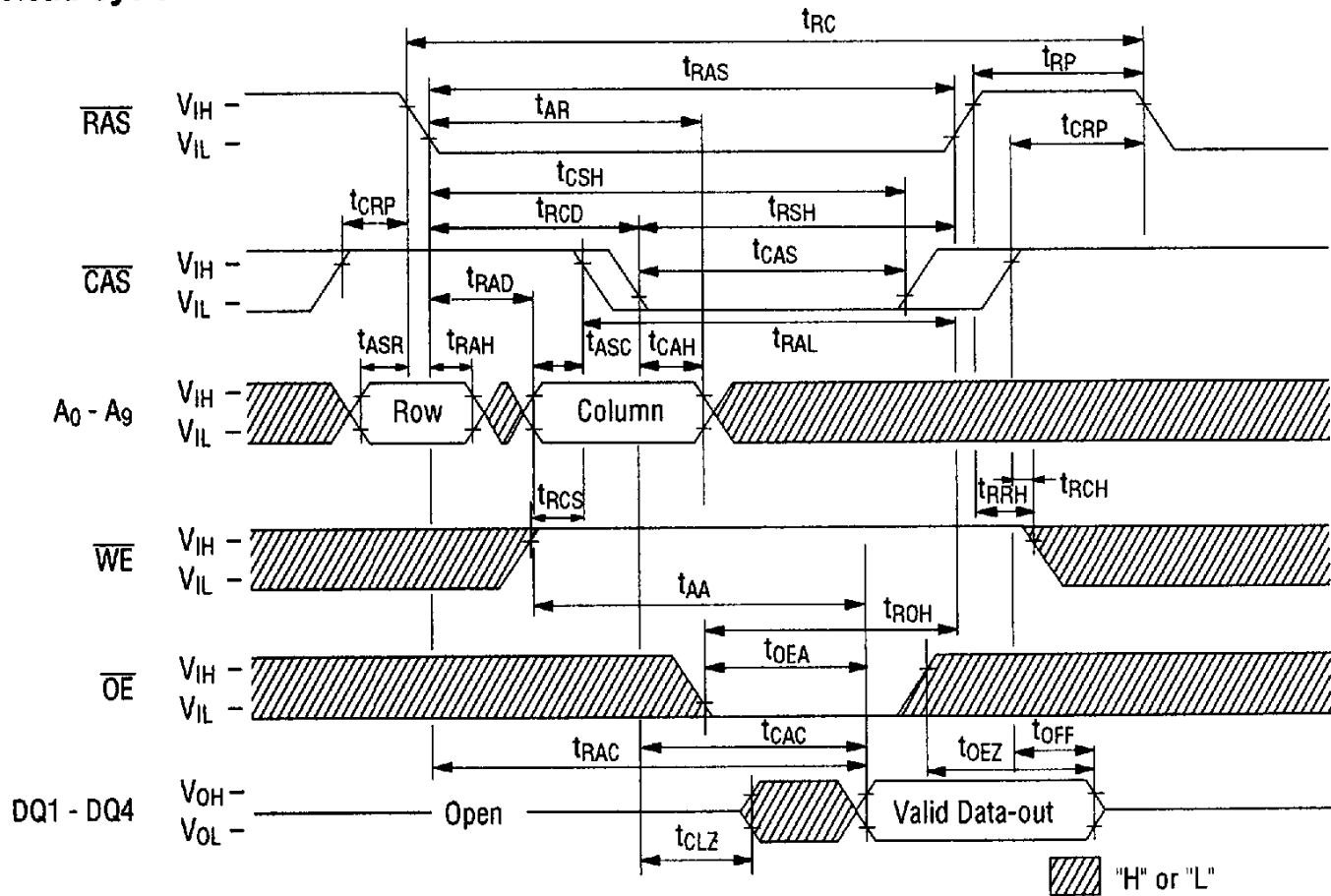
- Notes:
1. An initial pause of 200 μ s is required after power-up followed by 8 or more initialization cycles ($\overline{\text{RAS}}$ -only refresh or $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh) before proper device operation is achieved.
 2. The AC characteristics assume $t_T = 5\text{ns}$.
 3. V_{IH} (Min.) and V_{IL} (Max.) are reference levels of input signals for timing measurement. Transition times (t_T) are measured between V_{IH} and V_{IL} .
 4. Measured with a load circuit equivalent to 2TTL loads and 100pF.
 5. Operating within the t_{RCD} (Max.) limit insures that t_{RAC} (Max.) can be met. t_{RCD} (Max.) is specified as a reference point only; If t_{RCD} is greater than the specified t_{RCD} (Max.) limit, then access time is controlled exclusively by t_{CAC} .
 6. Operating within the t_{RAD} (Max.) limit insures that t_{RAC} (Max.) can be met. t_{RAD} (Max.) is specified as a reference point only; If t_{RAD} is greater than the specified t_{RAD} (Max.) limit, then access time is controlled exclusively by t_{AA} .
 7. t_{OFF} (Max.) defines at which time the output data achieves the open circuit condition and is not referenced to output voltage levels.
 8. Either t_{RRH} or t_{RCH} must be satisfied for a read cycle.
 9. t_{WCS} , t_{RWD} , t_{CWD} and t_{AWD} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; If $t_{WCS} \geq t_{WCS}$ (Min.) the cycle is an early write cycle and the data out will remain open circuit throughout the entire cycle; If $t_{CWD} \geq t_{CWD}$ (Min.), $t_{RWD} \geq t_{RWD}$ (Min.) and $t_{AWD} \geq t_{AWD}$ (Min.) the cycle is a read modify write cycle and the data out will contain data read from the selected cell. If neither of the above sets of conditions is satisfied, the condition of data out (at access time) is indeterminate.
 10. These parameters are referenced to $\overline{\text{CAS}}$ leading edge in an early write cycle and to $\overline{\text{WE}}$ leading edge in a $\overline{\text{OE}}$ control write cycle or a read modify write cycle.
 11. Test Mode Feature:

The test mode is activated by executing a $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh cycle with $\overline{\text{WE}}$ held at a low level (V_{IL}). The device remains in the test mode until it is deactivated by executing a standard $\overline{\text{RAS}}$ -only refresh or a $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ refresh cycle with $\overline{\text{WE}}$ held at a high level (V_{IH}).

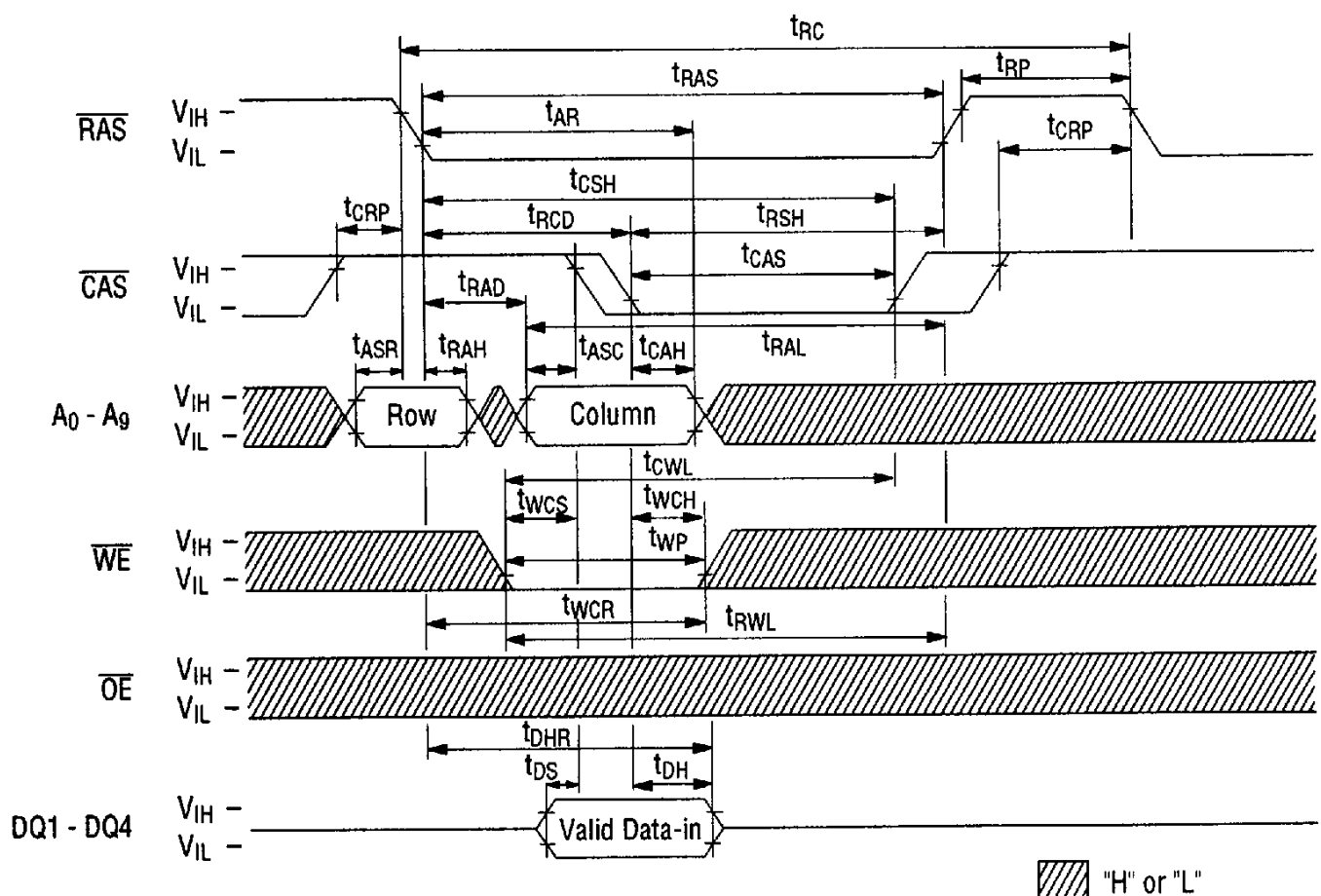
In the test mode CA0 is not used and each I/O pin now accesses 2 bit locations. Since all 4 I/O pins are used, a total of 8 data bits can be written in parallel into the memory array, reducing test time by 50%. When executing a read cycle 2 data bits are gated through the internal exclusive OR logic and the result is presented at the I/O pin, thus if the 2 data bits are equal, the I/O pin indicates a logical 1. If the 2 data bits are not equal, the I/O pin indicates a logical 0. This additional internal operation delays access time by 5ns and should be added to the access time parameters if operating in the test mode.

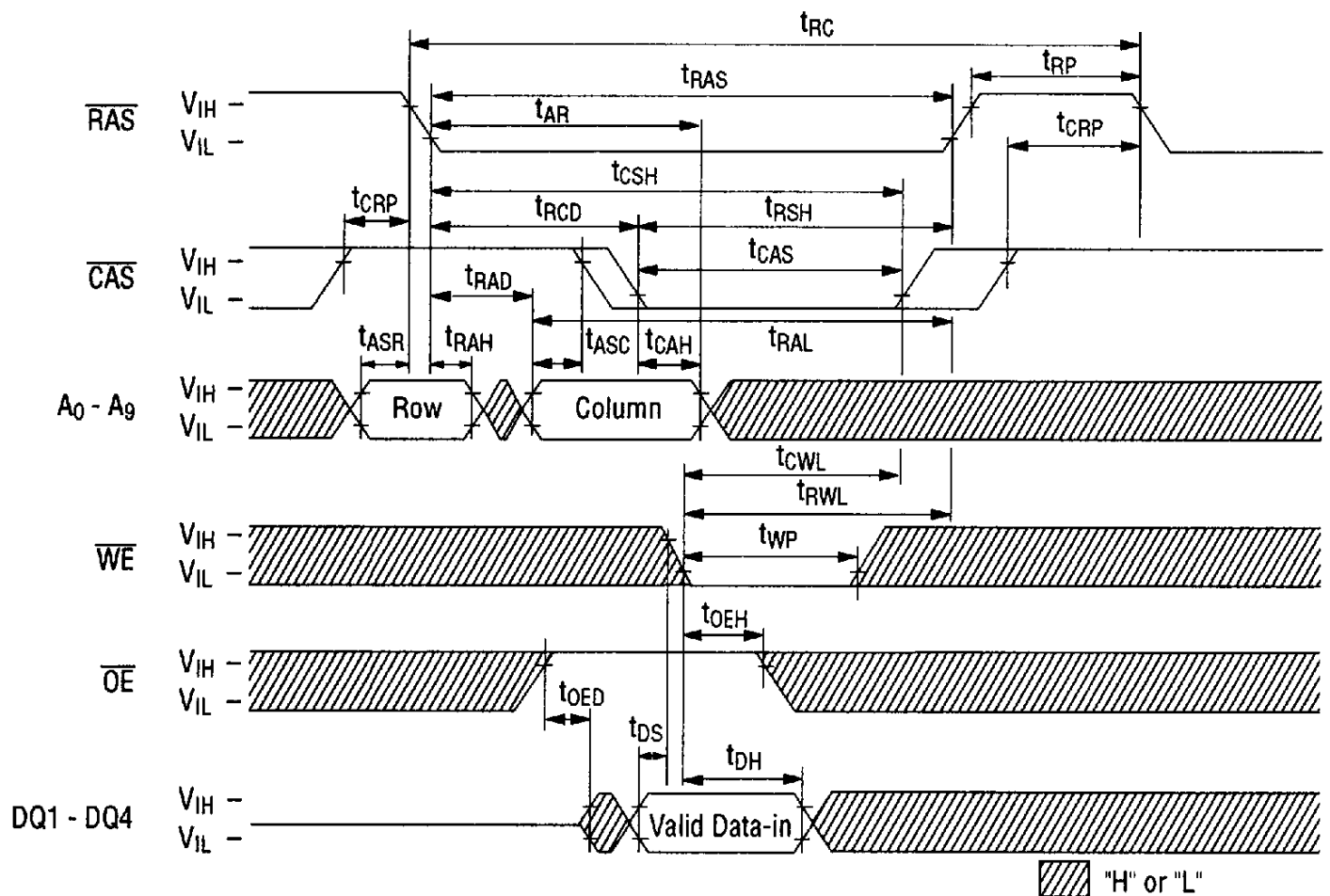
TIMING WAVEFORM

Read Cycle

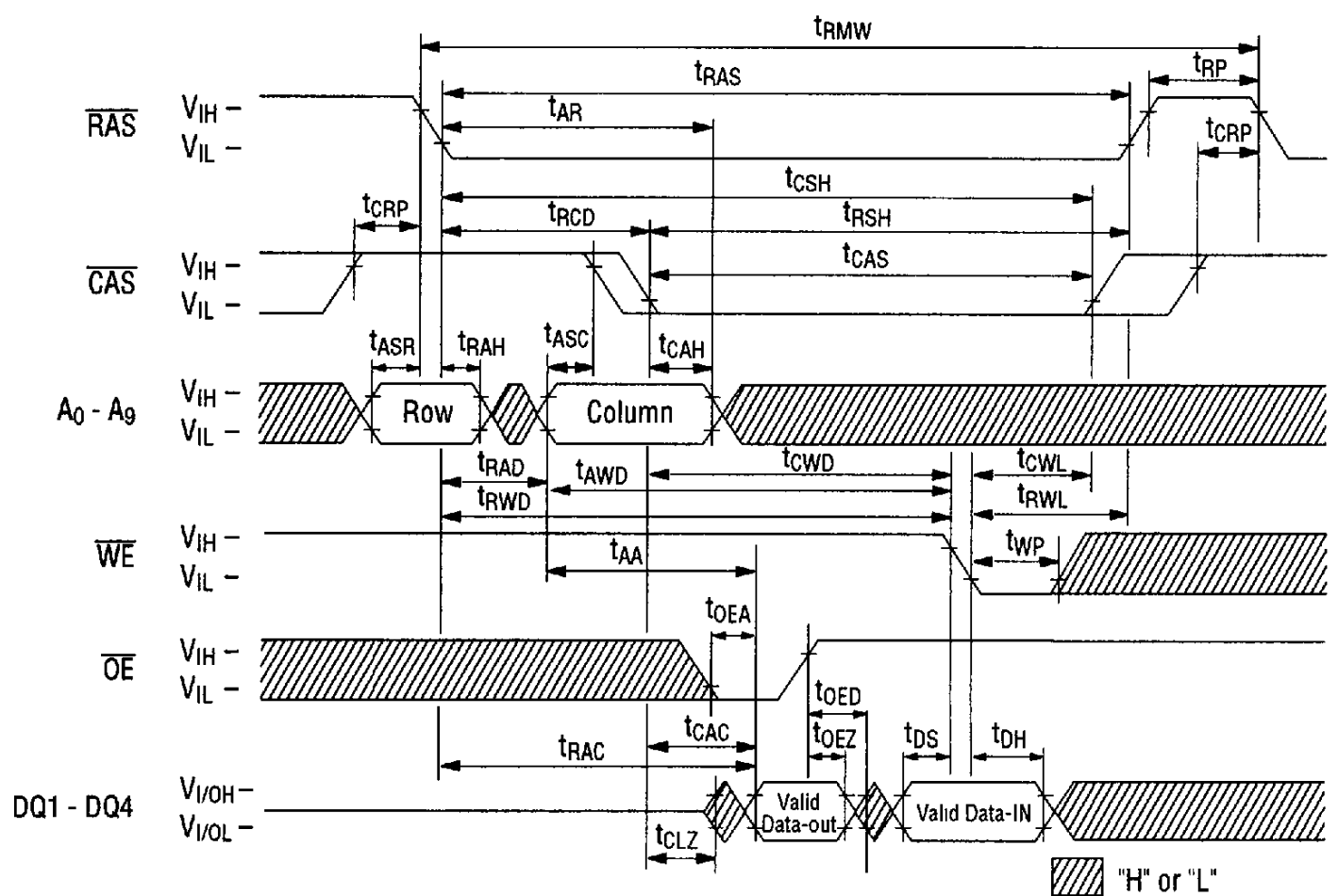


Write Cycle (Early Write)



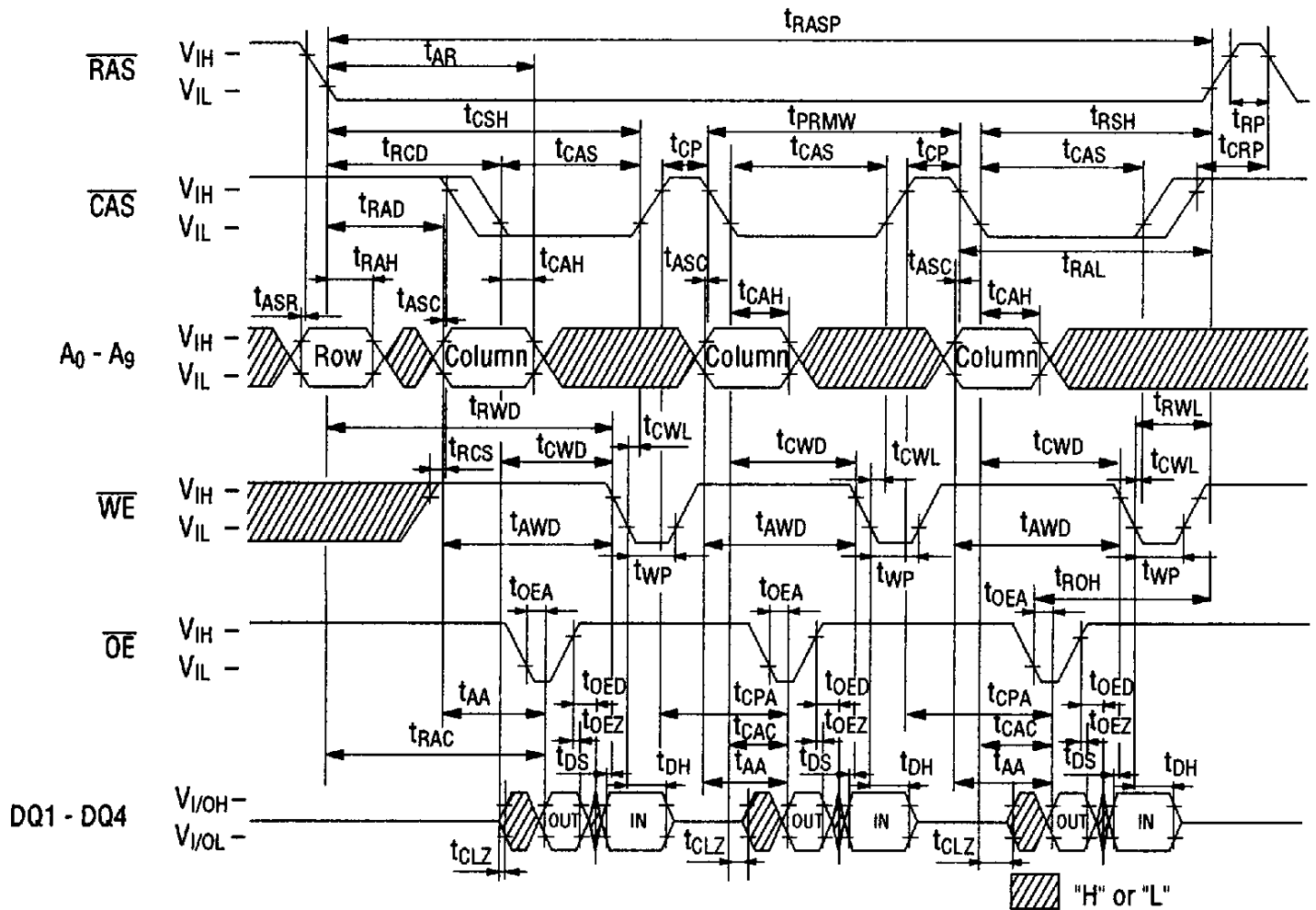
Write Cycle ($\overline{\text{OE}}$ Control Write)

Read Modify Write Cycle

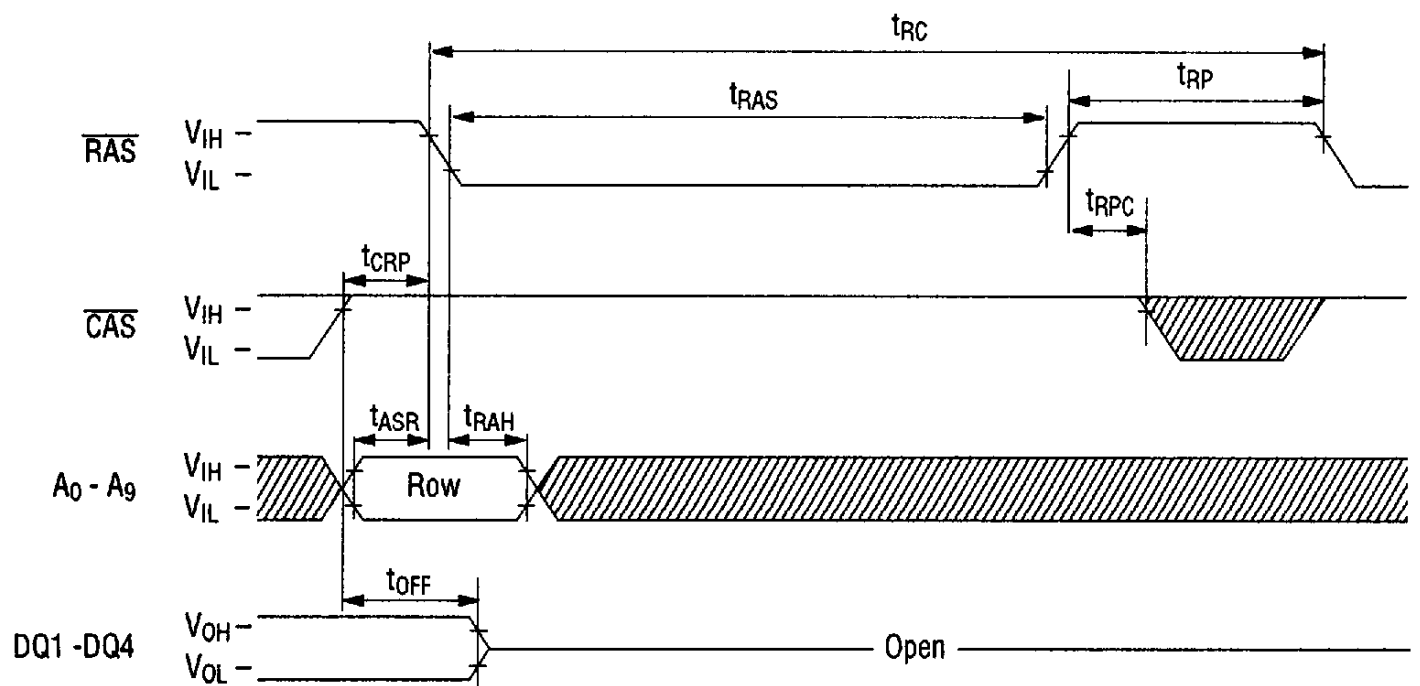


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Fast Page Mode Read Modify Write Cycle

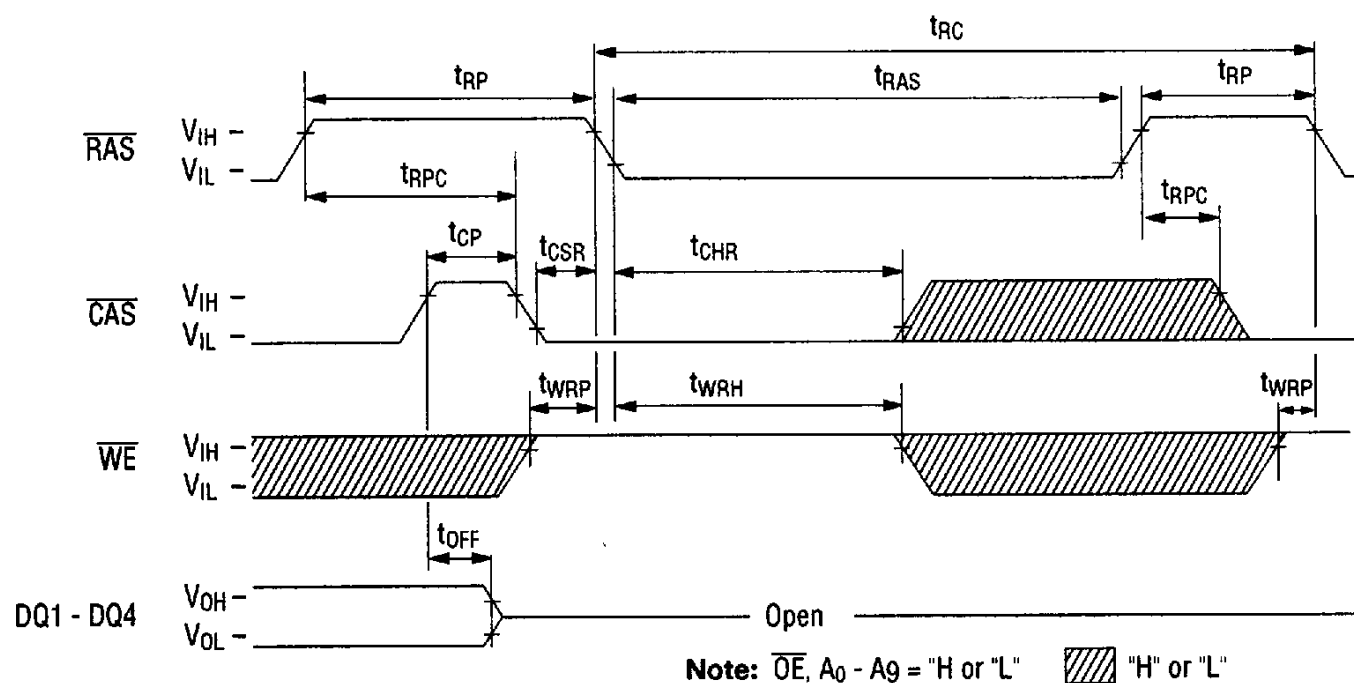


RAS-only Refresh Cycle

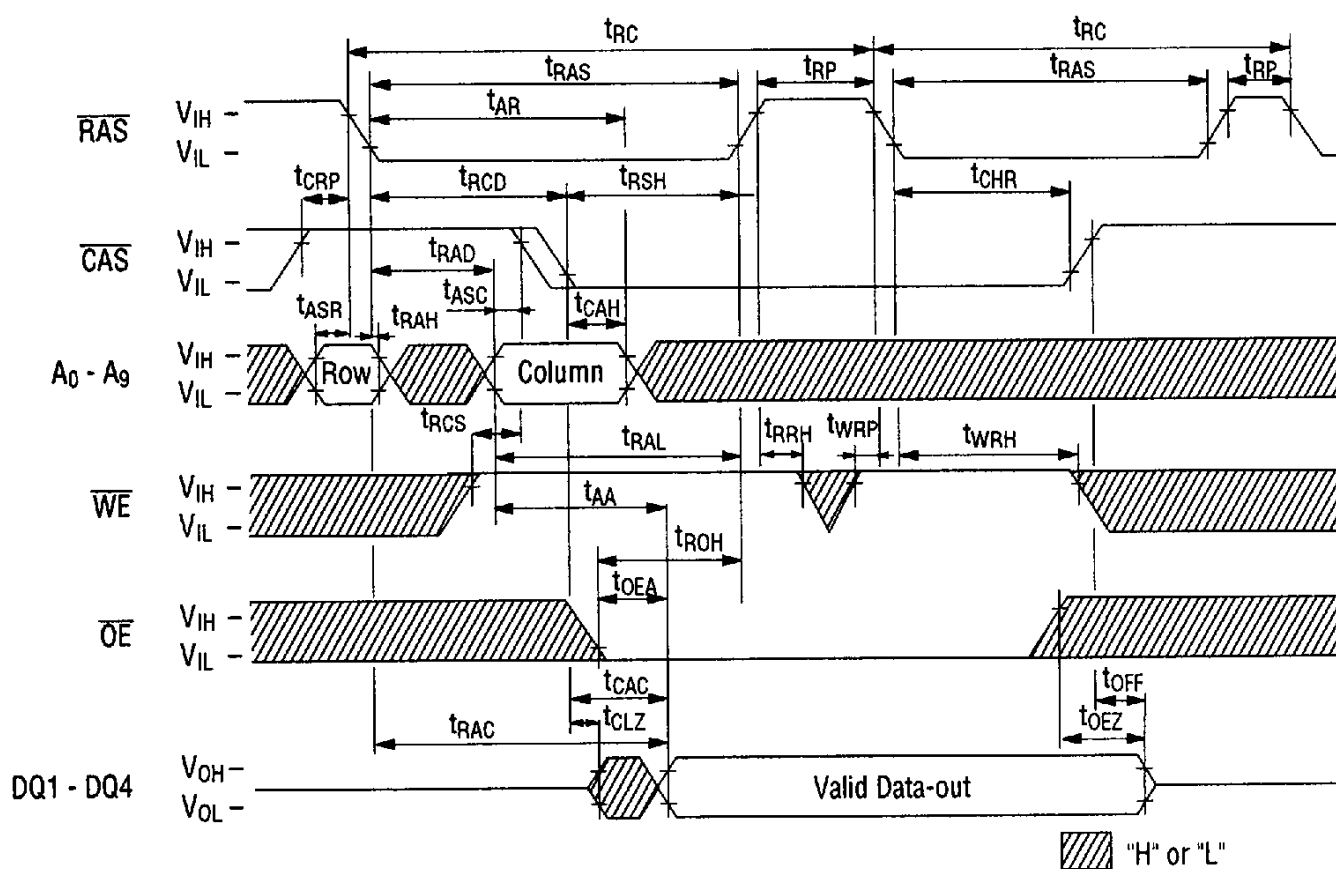


Note: DQ is open, $\overline{WE}$, $\overline{OE}$ = "H" or "L"  "H" or "L"

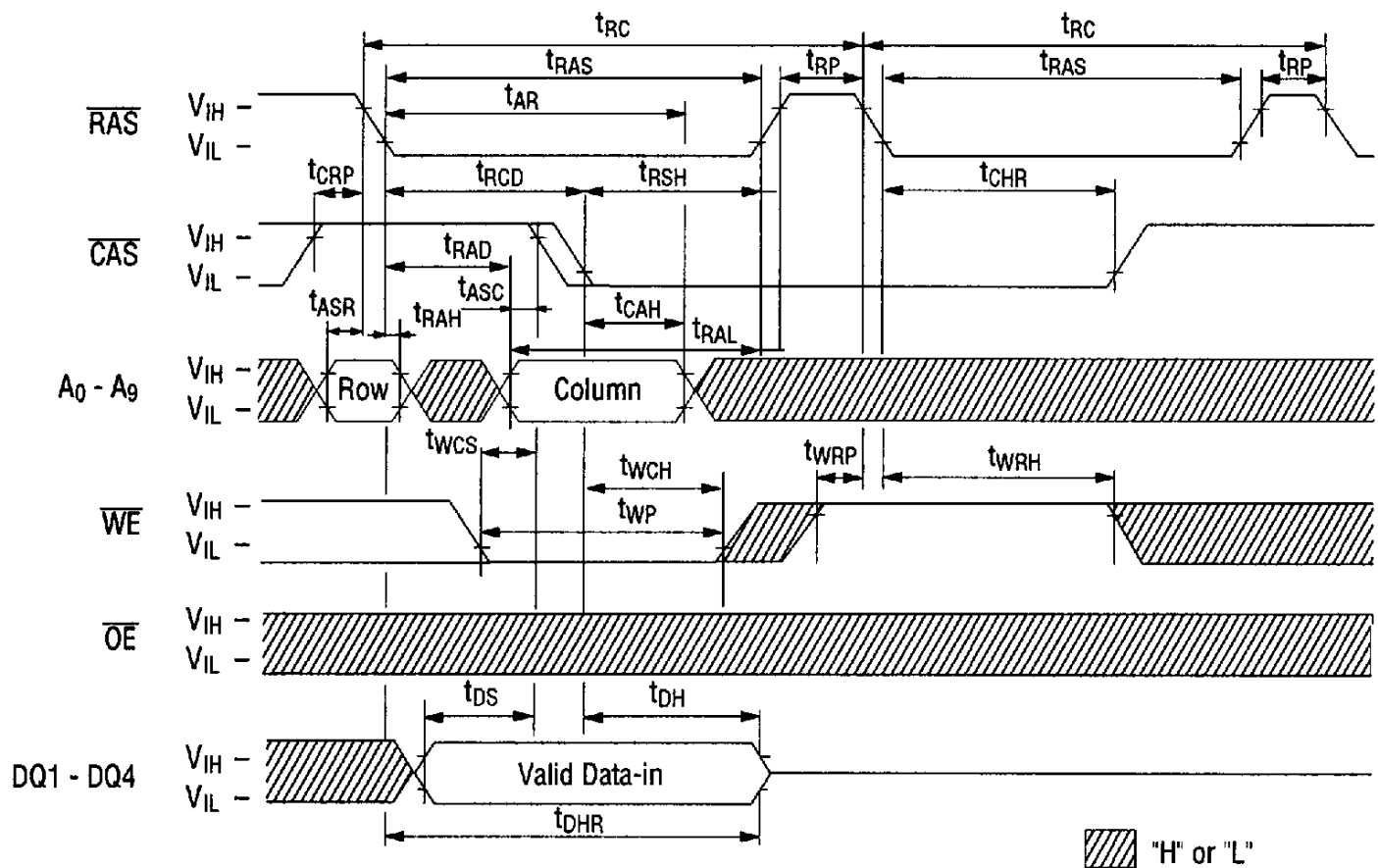
CAS Before RAS Auto-refresh Cycle



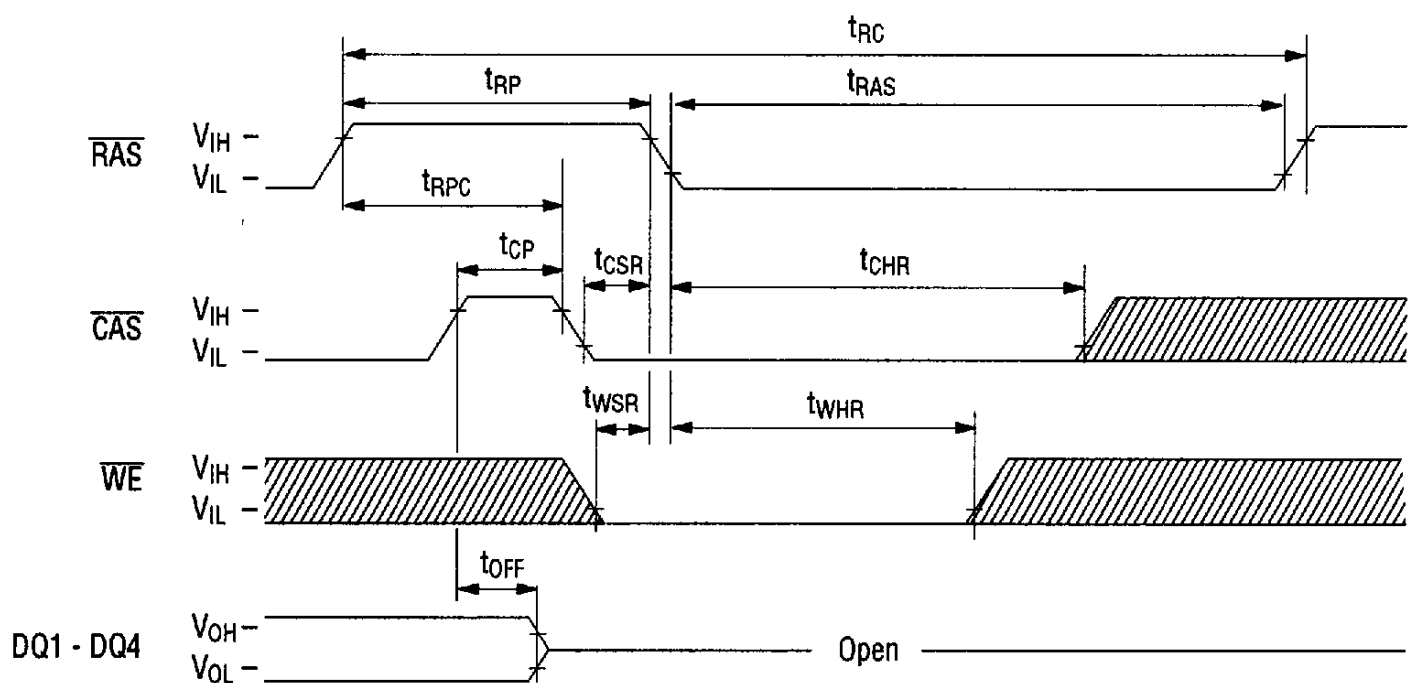
Hidden Refresh Read Cycle



Hidden Refresh Write Cycle



Test Mode Initiate Cycle



Note: $\overline{OE}$, $A_0 - A_9$ = "H" or "L" "H" or "L"

CAS Before RAS Refresh Counter Test Cycle

